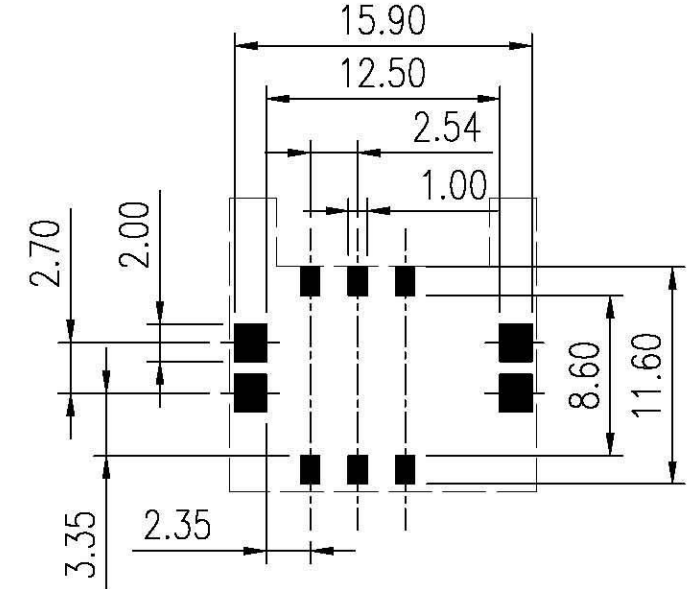
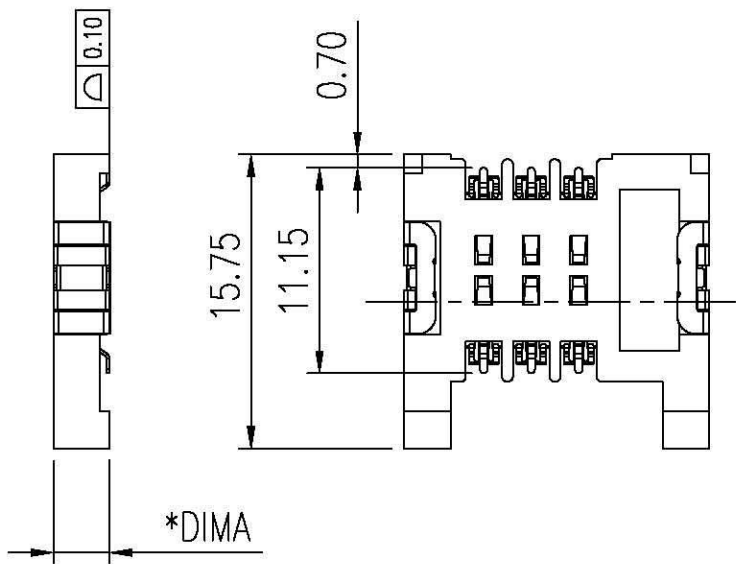
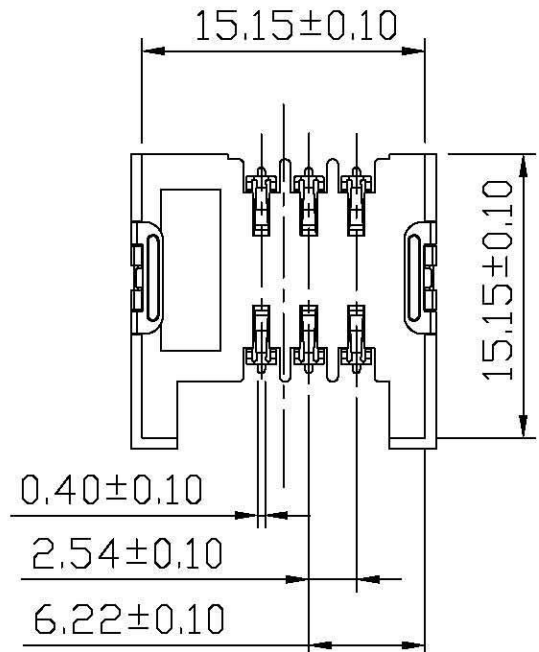


H2.5~3.6 SIM CARD

REV	DATE	DESCRIPTION	ECN NO.	NAME
PA	07.12/28	NEW RELEASE		



Recommended P.C.B. Layout(Tolerance=±0.05)
AS VIEW FORM COMPONENT SIDE

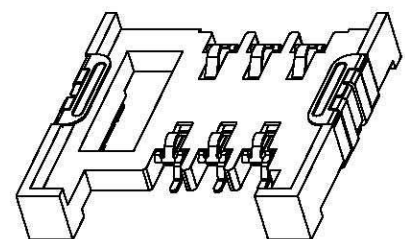
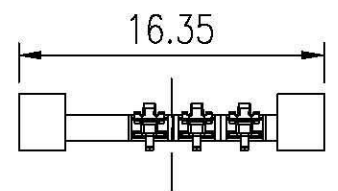


TABLE:

SGSIMEK25DD3625	2.50
SGSIMEK25DD3626	2.60
SGSIMEK25DD3627	2.70
SGSIMEK25DD3628	2.80
SGSIMEK25DD3629	2.90
SGSIMEK25DD3630	3.00
SGSIMEK25DD3631	3.10
SGSIMEK25DD3632	3.20
SGSIMEK25DD3636	3.60
PART NO.	DIM A

NOTES:
 1. MATERIAL
 HOUSING:LCP, UL94V-0; COLOR:BLACK
 CONTACT:PHOSPHOR COPPY, T=0.15
 STATOR:SUS301-1/4H, T=0.15
 2. FINISH
 CONTACT: NICKEL UNDERPLANED AND GOLD PLANTING OVER ALL
 SHELL: NICKEL UNDERPLANED AND TIN PLANTING

Wellco T&C Co., Ltd.

▽:Critical Dim *:Major	CUSTOMER P/N: 耳扣式 SIM卡座 H=2.5-3.6	PART NO.: SGSIMEK25DD36	
	TOLERANCE: X.X ±0.35 X.XX ±0.25 ANGLE ±3°	DRAWN BY	DRAWING NO.
	CHECKED BY	DRAWING SIZE	2:1
	APPROVED BY	UNIT	mm
	SORTING NO.	PAGE	1 OF 1